MIPI-OPT08

User Manual

Version 1.1



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1. Summary

1-1. Product Specification

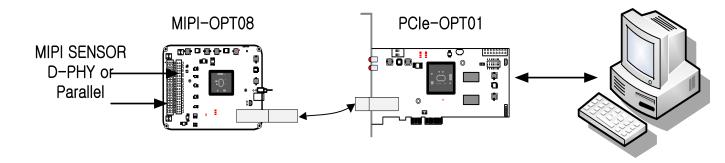
Item	Description	Remark
Hardware		
PC Interface	Fiber-Transmission Transceiver	SFP(small Form Factor)
Operation Power	+12VDC/400mA	External 12V DC Power
		(A6-Type: 5.5x2.1mm)
Video Interface	MIPI CSI D-PHY 4 Lane	1.2Gbps / 1 Lane
	Parallel Image Signal	16bit BT 601/656
Input/Output No.	Sensor GPIO 4bit	
	General GPIO 8bit	
On-board Memory	Non-condensing	
Communication	I2C/SPI	
Number of boards used	Max. 4	
simultaneously		
Software		
OS	Windows 2000/XP/7/8/10 (32/64bit)	Use with PCIe-OPT01
API		
Development		
Support		
Environmental conditions		
Operating temperature range	$0 \sim 50^{\circ}\text{C}$ (0 ~ 60°C when using fan)	
Storage temperature range	-20 ~ 80℃	
Humidity range	Non-condensing	
Board size	110mm x 80mm	PCB Board Size
	140mm x 80mm	Size including Case/SFP

1-2. Application Field

- Frame Grabber
- Test for Variable MIPI Sensor

The MIPI-OPT08 board transmits a parallel I/O signal or a D-PHY MIPI (Mobile Industry Processor Interface) signal to a PC in an optical manner through an external I/O connector. Parallel signal or D-PHY two signals can be selected and used. The received signal is processed by the software (application) provided by the DAC system in the PC and displayed as an image.

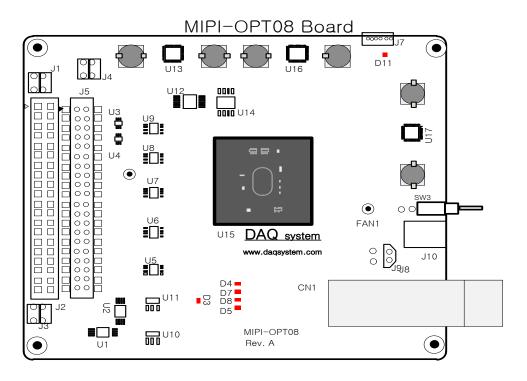
[Figure 1-1] shows an example of using the input board.



[Figure 1-1. MIPI-OPT08 Example of Use]

2. MIPI-OPT08 Board Description

2-1. Layout



[Figure 2-1. MIPI-OPT08 Layout]

No.	Name	Description/Remark	
1	CN1	SFP (8Gbps)	
2	U13, U16, U17	1.2V, 2.5V, 3.3V	
4	U15	FPGA	
5	J2	Parallel Signal Connector	
6	J5	MIPI D-PHY Signal Connector	
8	J11	Power Adaptor (12V)	
9	SW3	Power Switch	

There are 6 important LEDs on the board, and the description of each is as follows.

D20: Lights up after completion of initialization.

D19: Vertical Synchronization signal line (Vsync) is connected. This is a table for visually checking Vsync.

D25: Horizontal Synchronization signal line (Hsync) is connected. This is a table for visually checking Hsync.

D26: Vertical Synchronization (Vsync) divided by 1/16 is displayed as a table.

This is a table for visually checking Vsync.

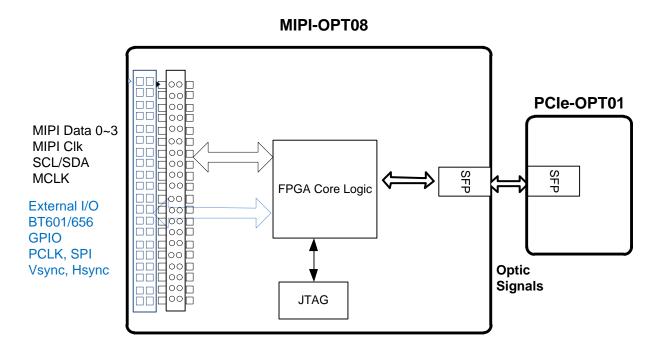
D3: Lights when the board is configured and ready for operation.

D11: Lights up when 3.3V power is applied.

2-2. Board Description

The MIPI-OPT08 board converts MIPI D-PHY or parallel sensor signals received from MIPI sensors and transmits light. All functions are controlled by the FPGA.

The block diagram of MIPI-OPT08 is as shown in [Figure 2-2].



[Figure 2-2. MIPI-OPT08 Block Diagram]

The program of the FPGA core logic uses JTAG, and functions to save the logic program in the FPGA Program Logic and download it when power is applied..

2-3. I/O Terminal Pin map

(1) CN1 Connector

In the case of MIPI-OPT06, a Small Form Factor Pluggable (SFP) connector is used as a Fiber-Transmission Transceiver. The SFP transceiver is designed to support various optical transmissions such as SONET, Gigabit Ethernet, and Fiber Channel. It supports hot-pluggable transceiver and can be connected to network device motherboard with fiber or copper networking cable.

The SFP is connected by a module that connects to the cage and connector, and has Tx (Transceiver) and Rx (Receiver) together.



[Figure 2-3. SFP & SFP Cage]

(2) J1 Connector

This connector is used to supply power with SP (sensor power).



[Figure 2-4. J1 Connector(Top View)]

[Table 1. J2 Connector Description]

No.	Name	Description
1	5V	5V

2	5V	5V
3	SP0	Sensor Power0
4	SP1	Sensor Power0

(3) J2 Connector (2x20 Pin Straight Female DIP Type)

It is connected to parallel signal and GPIO (General Purpose I/O), and the signals are as follows.

2	4	6	8	10	12	14	16	18	20	22	24	26	28	30	32	34	36	38	40
1	3	5	7	9	11	13	15	17	19	21	23	25	27	29	31	33	35	37	39

[Figure 2-5. J2 Connector (Top View)]

[Table 2. J2 Connector Description]

No.	Name	Description	Remark
1	CP_D0	Data0	3.3V
2	CP_D1	Data1	3.3V
3	CP_D2	Data2	3.3V
4	CP_D3	Data3	3.3V
5	CP_D4	Data4	3.3V
6	CP_D5	Data5	3.3V
7	CP_D6	Data6	3.3V
8	CP_D7	Data7	3.3V
9	GND	Ground	
10	GND	Ground	
11	CP_D8	Data8	3.3V
12	CP_D9	Data9	3.3V
13	CP_D10	Data10	3.3V
14	CP_D11	Data11	3.3V
15	CP_D12	Data12	3.3V
16	CP_D13	Data13	3.3V
17	CP_D14	Data14	3.3V
18	CP_D15	Data15	3.3V
19	GND	Ground	
20	GND	Ground	
21	C_PCLK	Pixel Clock	3.3V
22	C_VSYNC	Vertical Sync.	3.3V

23	C_HSYNC	Horizontal Sync.	3.3V
24	C_DE	Data Enable	3.3V
25	GND	Ground	
26	GND	Ground	
27	GPIO0	General Purpose I/O0	Using the PCI_DIO_xxx function
28	GPIO1	General Purpose I/O1	Using the PCI_DIO_xxx function
29	GPIO2	General Purpose I/O2	Using the PCI_DIO_xxx function
30	GPIO3	General Purpose I/O3	Using the PCI_DIO_xxx function
31	GPIO4	General Purpose I/O4	Using the PCI_DIO_xxx function
32	GPIO5	General Purpose I/O5	Using the PCI_DIO_xxx function
33	GPIO6	General Purpose I/O6	Using the PCI_DIO_xxx function
34	GPIO7	General Purpose I/O7	Using the PCI_DIO_xxx function
35	GND	Ground	
36	GND	Ground	
37	C_SPI_SCK	SPI Clock	3.3V
38	C_SPI_MISO	SPI MISO	3.3V
39	C_SPI_SSN	SPI Select	3.3V
40	C_SPI_MOSI	SPI MOSI	3.3V

(4) J3 Connector

This connector is used to supply power with SP (sensor power).



[Figure 2-6. J3 Connector (Top View)]

[Table 3. J3 Connector Description]

No.	Name	Description
1	SP4	Sensor Power2
2	SP5	Sensor Power3
3	5V	5V
4	5V	5V

(5) J4 Connector

This connector is used to supply power with SP (sensor power).



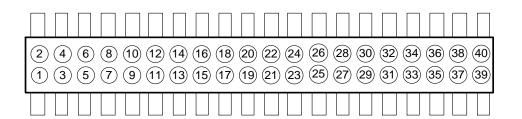
[Figure 2-7. J5 Connector (Top View)]

[Table 4. J4 Connector Description]

No.	Name	Description
1	5V	5V
2	5V	5V
3	SP2	Sensor Power2
4	SP3	Sensor Power3

(6) J5 Connector (2x20 Pin Straight Male SMD Type)

It is connected to the MIPI SENSOR board and the signals are as follows.



[Figure 2-8. J5 Connector (Top View)]

[Table 5. J5 Connector Description]

No.	Name	Description	Remark
1	SP0	SENSOR Power	
2	SP1	SENSOR Power	
3	SP2	SENSOR Power	
4	SP3	SENSOR Power	
5	GND	Ground	
6	GND	Ground	
7	SCL	Serial Clock	
8	DATAP_0	MIPI 1 Lane Positive	

9	SDA	Serial Data	
10	DATAN_0	MIPI 1 Lane Negative	
11	GND	Ground	
12	GND	Ground	
13	ENB	Enable	
14	DATAP_1	MIPI 2 Lane Positive	
15	S_RESET	Reset	
16	DATAN_1	MIPI 2 Lane Negative	
17	GND	Ground	
18	GND	Ground	
19	CNT0	Sensor GPIO0	Using the PCI_SDIO_xxx function
20	DATAP_2	MIPI 3 Lane Positive	
21	CNT1	Sensor GPIO01	Using the PCI_SDIO_xxx function
22	DATAN_2	MIPI 3 Lane Negative	
23	GND	Ground	
24	GND	Ground	
25	CNT2	Sensor GPIO2	Using the PCI_SDIO_xxx function
26	DATAP_3	MIPI 4 Lane Positive	
27	CNT3	Sensor GPIO3	Using the PCI_SDIO_xxx function
28	DATAN_3	MIPI 4 Lane Negative	
29	GND	Ground	
30	GND	Ground	
31	GND	Ground	
32	CLKP	MIPI Clock Positive	
33	GND	Ground	
34	CLKN	MIPI Clock Negative	
35	MCLK	Master Clock	
36	GND	Ground	
37	GND	Ground	
38	GND	Ground	
39	SP4	SENSOR Power	
40	SP5	SENSOR Power	

(7) J8 Connector

This connector is used when 12V is used as main power when connecting jumpers.

(8) J9 Connector

External input 12V power connector.

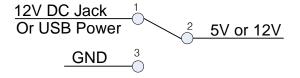
(9) J10 Power Jack

It is an external 12V DC Jack (A6 Type: 5.5x2.1mm) power connector of DC-005(2.0) standard. (Recommended for basic use)

[Figure 2-9. Rated power]

(10) SW3 Switch

When the terminal is raised with the board power On/Off switch, the 12V power is turned on.

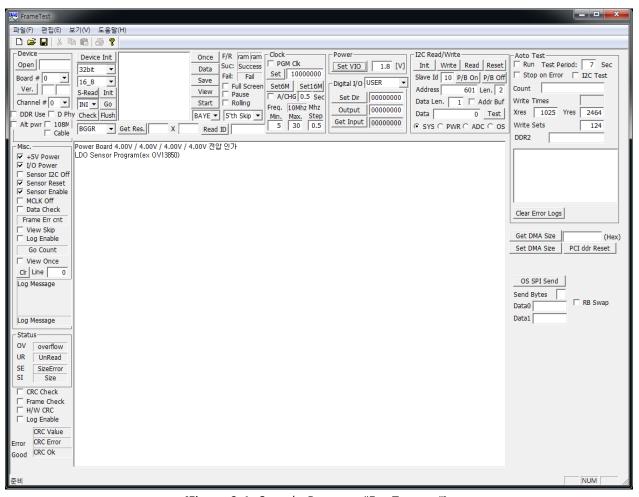


[Figure 2-10. SW3 Switch]

3. Sample Program

In the Exe folder of the CDROM provided with the board, a sample program "FrameTest.exe" is provided for easy use of the board. This program runs on a PC equipped with a PCIe-OPT01 board. By displaying Frame Data as a hexadecimal value, it is stored in memory or hard disk so that developers can utilize the frame data needed. In order to test the sample program, the driver of the board must be installed first.

The sample program is provided in the form of a source so that the API provided to use the board can be tested briefly, so the user can modify it and use it.



[Figure 3-1. Sample Program "FrmTest.exe"]

API (Application Programming Interface) is required to use the above sample program. API is provided in the form of "DLL", and import library and header file are required to compile. All files specified above are included on the supplied CDROM. In order to run the sample program normally, it must be in the API DLL (mipi_iot.dll) or in the Windows system folder or the folder specified by the Path environment variable.

The description of each menu bar is as follows. The menu bar not described here is an unused function.

(Note) The sample program execution sequence is to select Board # and Channel # first, then click "Open" → Select the format suitable for the camera in "Data mode" → Select the camera data width Select from among "8, 16, 24, 32bit" → "Device Init" → Select the sensor *.ini file in S-Read (*.ini file address and data selection, in case of D-Phy, select D Phy) → Go (Check "Get Res." resolution) → Image is real-time show

3.1 Board Function



(1) "Device Open" button

Starts the device of the selected board. If it is "0", it means that there is no device or no connection.

(2) "Board #:"

If the board is multi, the board number is assigned.

Currently, 4 can be selected from 0 to 3. Each board number is identified by a switch (J10) in the board..

(3) " Ver." button

Shows the current FPGA version and firmware version.

(4) "Channel #:"

Specifies the fiber channel number. If it is "0", it is connected to the lower optical channel (CN2), and if it is "1", it is connected to the upper optical channel (CN1).

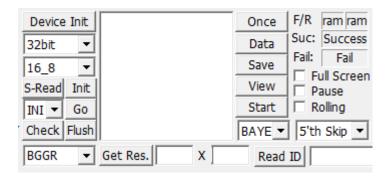
(5) "Sample Input": Among MIPI-OPT06 or MIPI-OPT08, the name of the board connected to PCIe-OPT01 appears.

DDR Use: It uses DDR memory.

D Phy: When selected, set D-Phy as the LVDS input mode. The default setting is C-PHY.

Virtual Channel: MIPI Virtual Channel is used when selected.

3.2 Image Frame Function



(1) "Device Init" button

Initialize the image frame function. It is performed only once when the first power is applied. Select Video Data Mode from among 8bit, 16bit, 24bit, and 32bit.

(2) "S-Read" button

Read the sensor initialization file. Depending on the address_data size (16_8, 16_16) above, it is possible to send commands to the INI file at once, or use I2C read/write commands line by line. The structure and description of the ini file are as follows. The following example is a 1 byte structure of address_data size of 16_8 address 2 bytes data.

Ex) SONY13M_full.ini file structure

```
[REGISTER]
Slave 0x10 //change slave ID as Sensor

SLEEP 100
0x3087 0x53
0x309D 0x94
0x30A1 0x08
0x30AA 0x04
0x30B1 0x00
0x30C7 0x00
0x3115 0x0E
0x3118 0x42
0x3121 0x0D
```

0x0100 0x01 //Streaming

(3) "Init" button

Initialize the sensor by selecting "SNI, T1, T2, SPI".

(4) "Go" button

Open the device, initialize it, open the corresponding ini file and get the resolution all at once

(5) "Check" button

Check the USB connection. In case of an error, "LVDS Check Error" is displayed.

(6) "Flush" button

Initialize the LVDS buffer.

(7) "RGGB;BGGR;GRBG;BGGR": Choose from Bayer Mode

(8) "Get Res." button

Shows the image resolution.

(9) "Once" button

Press the Toggle button to display the screen once.

(10) "Data" button

It reads the image frame saved on the board to the PC (Hexa value). If the image frame is not saved on the board, you have to wait until the saving is completed.

(11) "Save" button

It is used to save the frame image data read into the PC as a binary file file.

(12) "View" button

Start sending images.

(13) "Start" button

Start image transfer with "Start" and "stop" Toggle buttons.

(14) "BAYER;RGB;YUV;USER": Select custom or image input format type

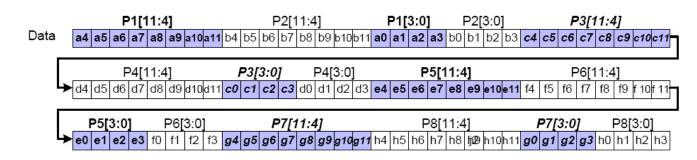
"No Skip; There is no byte skip.

"5'th Skip": When input data is 10bit RAW data, skip the 5th byte on selection.

For example, if the input data is a 10-bit Bayer, 8 bits are stored in the 5th byte, each of which is 1 bit excluding 3 bytes of RGB and 1 byte. When the Bayer is processed and displayed on the screen, the 5th byte is not needed, so it is used to remove it.

	P1[9:2]					P2[9:2]						P3[9:2]								P4[9:2]						
Data	a2 a3 a4 a5	a6 a7	a8	a9 t	2 b3	b4	b5	b6 l	b7 b	8 b9	c2	сЗ	с4	с5	с6	с7	c8	c9	12 d	3 d	4 d5	d6	d7 d	8 d9	Ъ	
_																										
	P1[1:0] P2[1:0]	1:0]	P5[9:2]						P6[9:2]							P7[9:2]										
L)	a0 a1 b0 b1	c0 c1	d0	d1 e	e2 e3	e4	e5	e6 e	e7 e	8 e9	f2	f3	f4	f5	f6	17	f8	f9 g	g2 g	13 g	4 g5	g6	g7 g	8 g9	Н	
_																									_	
	P8[P	P5[1:0] P6[1:0] P7[1:0] P8[1:0]						P9[9:2]							P10[9:2]										
L)	►h2 h3 h4 h5	h6 h7	h8	h9 e	e0 e1	f0	f1	g0 g	g1 h	0 h1	i2	i3	i4	i5	i6	i7	i8	i9	2 j	3 j4	4 j5	j6	j7 j8	3 j9]	

"3'th Skip": When input data is 12bit RAW data, skip the 3th byte on selection.



(15) "F/R:": (Right) Shows the number of frames displayed on the screen.

(Left) Shows the actual number of frames sent from the sensor.

"Suc: ": Shows the number of successful image transfers.

"Fail: ": Shows the number of failed image transfers.

"Full Scr.": Displays the screen in real resolution.

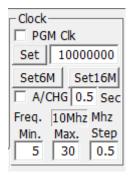
"Pause": Pause the screen.

"Rolling": Update image data without using GetFrame function.

(16) "Read ID" button

Shows MIPI ID.

3.3 Clock Function



(1) "PGM Clk" toggle

Select the corresponding Sensor Clock.

(2) "Set" button

It is set according to the frequency set next to the Sensor Clock. In the above case, it is set to 10MHz.

(3) "Set 6M" button

Set the Sensor Clock to 6MHz.

(4) "Set 16M" button

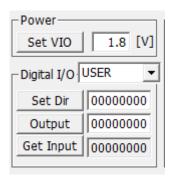
Set the Sensor Clock to 16MHz..

(5) "A/CHG" toggle

If you check, the Min. Max. It can be tested by periodically setting the interval of the frequency determined by Step.

Ex) In the above case, the frequency increases in units of 0.5MHz between 5 and 30MZ, and the period increases in units of $0.5 \times 1000ms = 500ms$ as the number next to A/CHG.

3.4 Power/Digital/IO Function



(1) "Set VIO" button

User GPIO7..0 IO voltage value (default 1.8V) can be specified and set. (0 ~ 3.3V)

(2) **Digital I/O (USER;Sensor;User3.3V;PWR)**: Selection

(Based on Power Board connection)

PCI_DIO_XXXX : User GPIO7..0 General Purpose I/O)
PCI_SDIO_XXXX : Sensor GPIO3..0 (General Purpose I/O)
PCI_DIO33_XXXX : User 3.3V GPIO3.3 (General Purpose I/O)
PCI_PWR_DIO_XXXX: Power GPIO GPIO11..0 (General Purpose I/O)

(3) "Set Dir" button

Set whether to use each GPIO port as input or output. If the last bit is "0", it is an input, and if it is "1", it is an output.

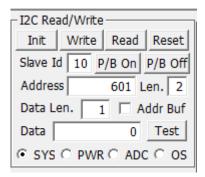
(4) "Output" button

According to the digital I/O selection, the value ("0" or "1") in the next box is output to the GPIO port.

(5) "Get Input" button

According to the digital I/O selection, the value of the GPIO input/output port is read.

3.5 I2C Function



(1) "Init" button

Initialize SYS/PWR/ADC/OS I2C communication speed. The initial speed is set to 100 KHz.

(2) "Write" Button

It writes the data of the corresponding address in the selected mode among the SYS, PWR, ADC, and OS modes below as much as the data size at the given address.

(3) "Read" Button

It reads the data of the corresponding address in the selected mode among the SYS, PWR, ADC, and OS modes below as much as the data size at the given address.

(4) "Reset" Button

Initializes the resources of the I2C system of the system (SYS) module.

(5) "Slave ID": Slave ID

"Address ": Slave Register Address

"Len.:": Address Value

"Data Len.:" : Data Value

"Addr Buf" toggle: Used in SYS mode when selected, address instead of address

use a buffer.

"Data:": data you want to send

The above values are variables used for I2C Read or I2C Write.

(6) "P/B On" or "P/B Off" button

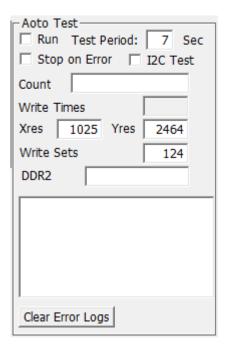
On/Off test the power 3.3V on the Power Board.

(7) "SYS": System Board

"PWR": Power Board

"ADC": AD Converter Board
"OS": Open Short Board

3.6 Auto Test Function



(1) "RUN" toggle: Device Open, Init, Clk Set, Sensor power test, etc. are repeatedly performed during the setting period of the Test Period according to the Write Times with the size of the Xres/Yres resolution given below.

"Test Period": The test cycle can be set in seconds.

"Stop on Err": Stop error output.

"I2C Test": Test I2C of SYS, PWR, ADC board.

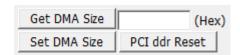
A related message appears on the log screen below, and in case of failure, a "Fail" message appears.

Count: AutoTest Count, Write error values and Reset Error values are output.

(2) "Clear Error Log" Button

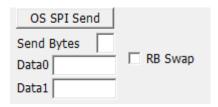
Clear the error log.

3.7 SPI Function



"Get DMA Size" Button: Get the DMA buffer size.
"Set DMA Size" Button: Set the DMA buffer size.
"PCI ddr Reset" Button: Initialize DDR memory.

3.8 OS SPI Function

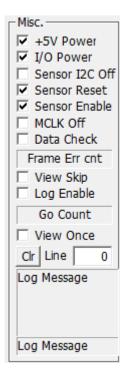


"OS SPI Send" button: Send data to the sensor.

"Send Bytes": The size of bytes to send to the sensor

"Data0": Data0 to send to sensor
"Data1": Data1 to send to sensor

3.9 MISC Function



Several types of states can be selected and used.

"+5V Power": Outputs VIO power.

"I/O Power": Turns on/off the power of external signals used for MIPI.

"Sensor I2C Off": Turns on/off the Sensor I2C operation.

"Sensor Reset": Set the Reset output of the Sensor to High or Low.

"Sensor Enable": Set Enable output of Sensor to High or Low.

"MCLK Off": Turns the master clock output On/Off.

"Data Check": If the frame data is an error, it is counted in the box below.

"View Skip": Stop the video

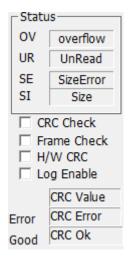
"Log Enable": Enable the log file in the upper right corner.

"View Once": Show the video once.

(1) "Clr" button

Initialize the log message screen below.

3.10 STATUS Function



It shows the number of the following 4 error states that occur during image transmission.

"OV": Overflow
"UR": UnRead
"SE": SizeError
"SI": Size

"CRC Check": Activate the LVDS Check Sum function.

"Frame Check": Enable Frame CRC.
"H/W CRC": Enable hardware CRC.
"Log Enable": Activate the Log screen.

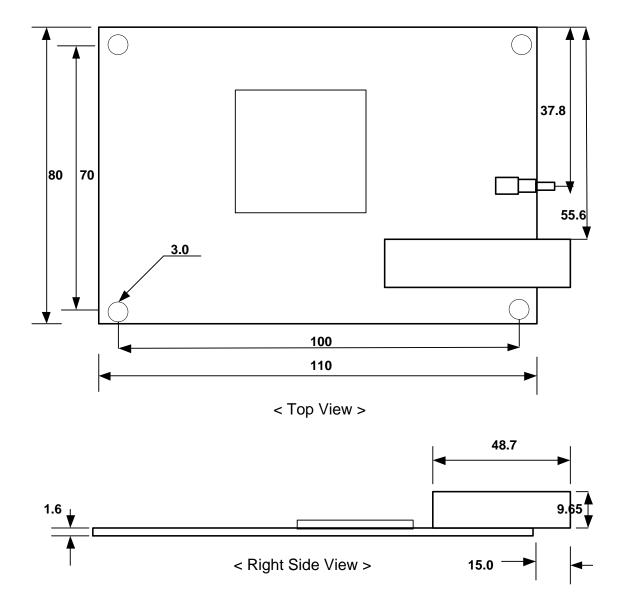
CRC Value: When CRC Check is performed, the CRC value is displayed. **CRC ERROR**: Shows the number of CRC errors when checking CRC **CRC OK**: When CRC Check, the number of CRC OKs is displayed.

Appendix

A-1. board Size

The external dimensions of the board are as follows.

(For detailed dimensions, please ask the person in charge.)



A-2. Repair Regulations

Thank you for purchasing a DAQSYSTEM product. Please refer to the following regarding customer service regulated by DAQSYSTEM.

- (1) Read the user manual before using the DAQSYSTEM product and follow the instructions.
- (2) When returning the product to be repaired, please include the symptoms of the failure and send it to the head office.
- (3) The warranty period for all DAQSYSTEM products is one year.
 - -. The warranty period is counted from the date the product is shipped from DAQSYSTEM.
 - Peripherals and third-party products not manufactured by DAQSYSTEM are covered by the manufacturer's warranty.
 - -. If you need repair, please contact the Contact Point below.
- (4) Even during the warranty period, repairs will be charged in the following cases.
 - 1 Failure or damage caused by use without following the user's manual
 - ② Breakdown or damage caused by customer's negligence during product transportation after purchase
 - 3 Failure or damage due to natural phenomena such as fire, earthquake, flood, lightning, pollution, or power supply exceeding the recommended range
 - 4 Failure or damage caused by inappropriate storage environment (eg, high temperature, high humidity, volatile chemicals, etc.)
 - (5) Breakdown or damage due to unfair repair or modification
 - 6 Products whose serial number has been changed or deliberately removed
 - ② If DAQSYSTEM determines that it is the customer's fault due to other reasons
- (5) Customer is responsible for shipping costs for returning the repaired product to DAQSYSTEM.
- (6) The manufacturer is not responsible for any problems caused by incorrect use, regardless of our warranty.

Contact Point

Web sit : https://www.daqsystem.com

Email: postmaster@daqsystem.com

